

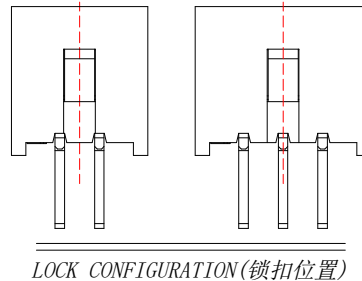
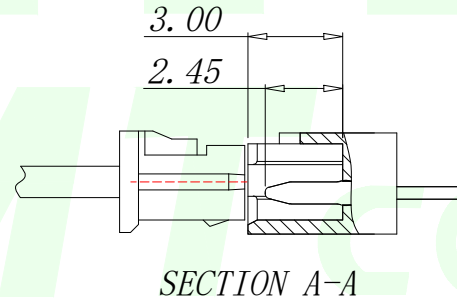
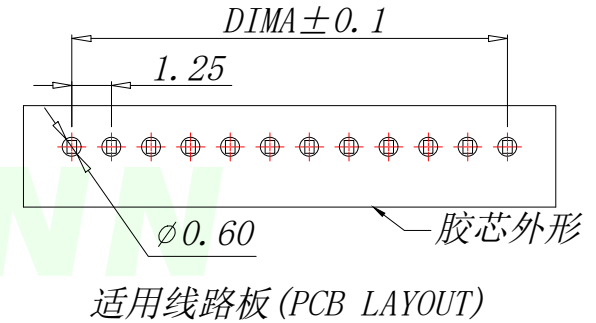
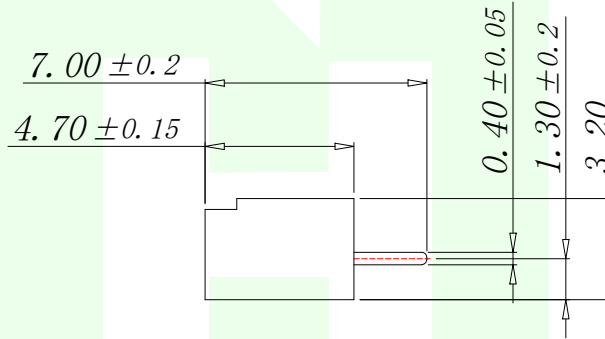
RoHs

Technical Index:

1. The surface of the plastic parts should be smooth, no rough edges, no obvious shrinkage, defects, cracks and other phenomena)
2. Lock Configuration: 2 to 3Pin is 1, ≥ 4 Pin is 2
3. Temperature range: $-25^{\circ}\text{C}\sim+85^{\circ}\text{C}$.
4. Rated voltage: 125V, AC/DC.
5. Contact resistance: $\leq 0.02\Omega$.
6. Insulation resistance: $\geq 100M\Omega$

VER	MARK	PR. BY	DESCRIPTION	DATE

Part No	Pin	A	B	C
W1251110-2PY2123	2	1.25	3.20	4.30
W1251110-3PY2123	3	2.50	4.45	5.55
W1251110-4PY2123	4	3.75	5.70	6.80
W1251110-5PY2123	5	5.00	6.95	8.05
W1251110-6PY2123	6	6.25	8.20	9.30
W1251110-7PY2123	7	7.50	9.45	10.55
W1251110-8PY2123	8	8.75	10.70	11.80
W1251110-9PY2123	9	10.00	11.95	13.05
W1251110-10PY2123	10	11.25	13.20	14.30
W1251110-11PY2123	11	12.50	14.45	15.55
W1251110-12PY2123	12	13.75	15.70	16.80
W1251110-13PY2123	13	15.00	16.95	18.05
W1251110-14PY2123	14	16.25	18.20	19.30
W1251110-15PY2123	15	17.50	19.45	20.55
W1251110-16PY2123	16	18.75	20.70	21.80
W1251110-17PY2123	17	20.00	21.95	23.05
W1251110-18PY2123	18	21.25	23.20	24.30
W1251110-19PY2123	19	22.50	24.45	25.55
W1251110-20PY2123	20	23.75	25.70	26.80



序号	品名	材质
1	1.25 Pitch S/T Wire To Board Housing DIP (H=4.7)	PA66 UL94V-2 Yellow
2	1.25 Pitch S/T Wire To Board Terminal DIP (H=4.7)	Copper Alloy/ Tin Plating

GENERAL TOLERANCES UNLESS SPECIFIED		HMTCONN 深圳市华明通电子有限公司 Shenzhen Huamingtong Electronics Co., Ltd		
X. [°] ±0.50	X. [°] ±5°	PART NO. W1251110-XPY2123	TITLE: 1.25 PITCH H4.7 S/T WIRE TO BOARD DIP CONN.	
X.X [°] ±0.20	X.X [°] ±3°		CUSTOMER	SIZE A4
X.XX [°] ±0.10	X.XX [°] ±1°	DESIGN: James		
MANUFACTURE DWG		CHED: Talen	SCALE N:A	SHEET 1/1
		APPD: Sophia		